

6th Generation CoolSiC™

650V SiC Schottky Diode

The CoolSiC[™] generation 6 (G6) is the leading edge technology from Infineon for the SiC Schottky barrier diodes. The Infineon proprietary innovative G5 technology was enhanced in G6 by introducing further advancements like a novel Schottky metal system. The result is a family of products with improved efficiency over all load conditions, resulting from a lower figure of merit (Q_c x V_f). The CoolSiC[™] Schottky diode 650 V G6 has been designed to complement our 600 V and 650 V CoolMOS™ 7 families, meeting the most stringent application requirements in this voltage range.

Table 1 **Key performance parameters**

Parameter	Value	Unit				
V_{RRM}	650	V				
$\overline{Q_C (V_R = 400 \text{ V})}$	14.7	nC				
$E_C (V_R = 400 \text{ V})$	2.7	μЈ				
$I_F (T_C \le 140 ^{\circ}\text{C}, D = 1)$	10	А				
$V_F (I_F = 10 \text{ A}, T_j = 25 \text{ °C})$	1.25	V				

Type / ordering Code	Package	Marking
IDH10G65C6	PG-TO220-2	D1065C6

PG-TO220-2 **CASE** 1) Cathode 2) Anode o CASE

Features

- Best in class forward voltage (1.25 V)
- Best in class figure of merit $(Q_c \times V_F)$
- High dv/dt ruggedness (150 V/ns)

Benefits

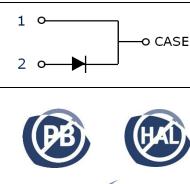
- System efficiency improvement
- System cost and size savings due to the reduced cooling requirements
- Enabling higher frequency and increased power density

Potential Applications

- Power factor correction in SMPS
- Solar inverter
- Uninterruptible power supply

Product Validation

Qualified for industrial applications according to the relevant tests of JEDEC (J-STD20 and JESD22)



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1 Maximum ratings

Table 3 Maximum ratings

Dawasatas	Complete !	Values			l lmit		
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note/Test condition	
	I_F	-	_	10		$T_C \le 140 ^{\circ}\text{C}, D = 1$	
Continuous forward current		-	-	13		$T_C \le 125 ^{\circ}\text{C}, D = 1$	
		-	-	24		$T_C \le 25 ^{\circ}\text{C}, D = 1$	
Surge-repetitive forward current, sine halfwave ¹	$I_{F,RM}$	-	-	44	A	$T_C = 25 ^{\circ}\text{C}, t_p = 10 \text{ms}$	
Surge non-repetitive forward	,	_	_	55		$T_C = 25 ^{\circ}\text{C}, t_p = 10 \text{ms}$	
current, sine halfwave	$I_{F,SM}$	_	_	44		$T_C = 150 ^{\circ}\text{C}, t_{\rho} = 10 \text{ms}$	
Non-repetitive peak forward current	I _{F,max}	-	-	600		$T_C = 25 ^{\circ}\text{C}, t_p = 10 \mu\text{s}$	
:24	(:2 -1+	_	_	15	۸2-	$T_C = 25 ^{\circ}\text{C}, t_p = 10 \text{ms}$	
i ² t value	∫ i²dt	_	_	10	A ² s	$T_C = 150 ^{\circ}\text{C}, t_\rho = 10 \text{ms}$	
Repetitive peak reverse voltage	V_{RRM}	_	_	650	٧	<i>T_c</i> = 25 °C	
Diode dv/dt ruggedness	dv/dt	_	_	150	V/ns	V _R = 0480 V	
Power dissipation	P _{tot}	_	-	72	W	$T_C = 25^{\circ}\text{C}, R_{thJC,max}$	
Operating and storage temperature	T_j T_{stg}	-55	-	175	°C	-	
Mounting torque	_	_	_	70	Ncm	M3 screw	

2 Thermal characteristics

Table 4 Thermal characteristics (PG-TO-220-2)

Doromotor	Values	l lmit	Note/Test condition			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note/Test condition
Thermal resistance, junction- case	R_{thJC}	_	1.3	2.1	12 /\AI	_
Thermal resistance, junctionambient	R_{thJA}	_	_	62	K/W	leaded
Soldering temperature, wavesoldering only allowed at leads	T_{sold}	-	-	260	°C	1.6 mm (0.063 in.) from case for 10 s

Final Datasheet 3 Rev. 2.0, 2017-05-23

¹ The surge-repetitive forward current test was performed with 1000 pulses (half-wave rectified sine with the 10 ms period).





3 Electrical characteristics

3.1 Static characteristics

Table 5Static characteristics

Parameter	Symbol	Values			11	Note /Test sou dition
		Min.	Тур.	Max.	Unit	Note/Test condition
DC blocking voltage	V_{DC}	650	-	_		<i>T_j</i> = 25 °C
Diode forward voltage	V_F	_	1.25	1.35	V	$I_F = 10 \text{ A}, T_j = 25 \text{ °C}$
		_	1.5	_		$I_F = 10 \text{ A}, T_j = 150 \text{ °C}$
Reverse current		_	$V_R = 420 \text{ V}, T_j = 25 \text{ °C}$			
	I_R	- 33 - μA V _R =	$V_R = 420 \text{ V}, T_j = 125 \text{ °C}$			
		_	77	_		$V_R = 420 \text{ V}, T_j = 150 \text{ °C}$

3.2 AC characteristics

Table 6 AC characteristics

Daramatar	Cumbal	Values			I Inch	Nata/Tast Can dition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note/Test Condition
Total capacitive charge	Q_c	-	14.7	-	nC	V_R = 400 V, T_j = 150 °C, di/dt = 200 A/ μ s, $I_F \le I_{F,MAX}$
		-	495	-		$V_R = 1 \text{ V, } f = 1 \text{ MHz,}$ $T_j = 25 \text{ °C}$
Total capacitance	С	-	29	-	pF	$V_R = 300 \text{ V}, f = 1 \text{ MHz},$ $T_j = 25 \text{ °C}$
		-	28	_		V_R = 600 V, f = 1 MHz, T_j = 25 °C



4 Diagrams

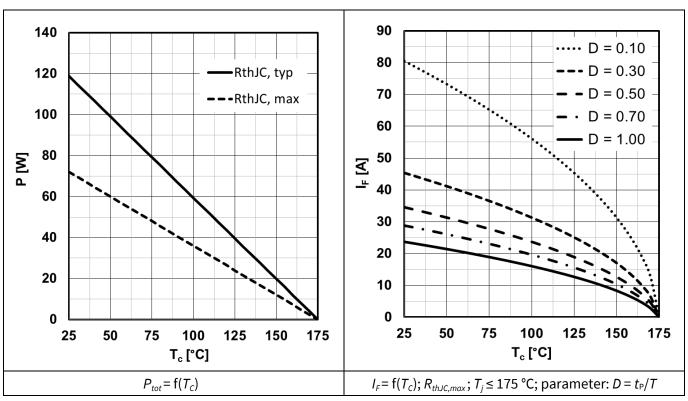


Figure 1 Power dissipation

Figure 2 Max. forward current

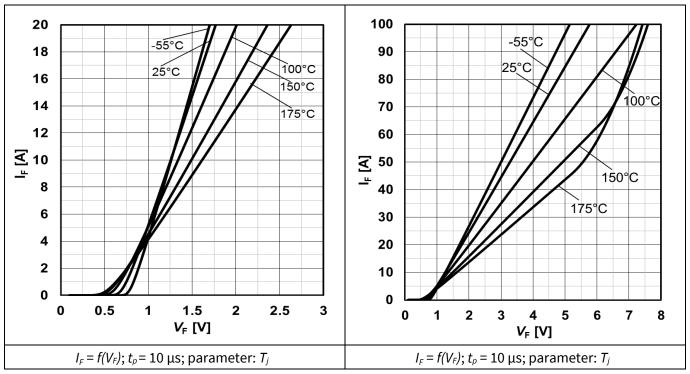


Figure 3 Typ. forward characteristics

Figure 4 Typ. forward characteristics in surge current



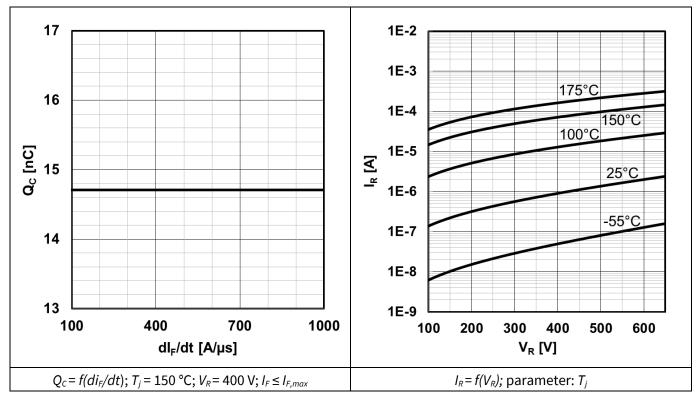


Figure 5 Typ. cap. charge vs. current slope

Figure 6 Typ. reverse current vs. reverse voltage

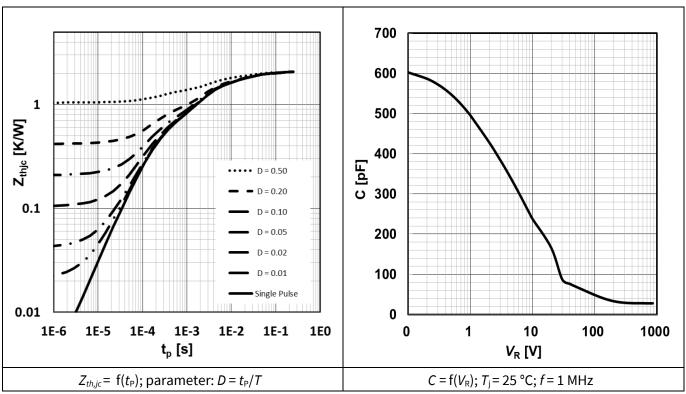


Figure 7 Max. transient thermal impedance

Figure 8 Typ. capacitance vs. reverse voltage



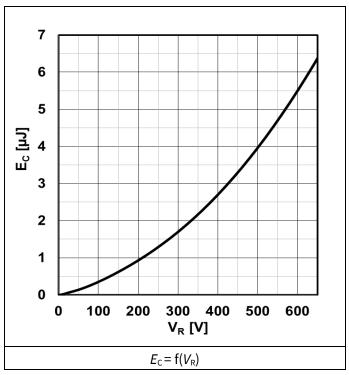


Figure 9 Typ. capacitance stored energy

5 Simplified forward characteristic

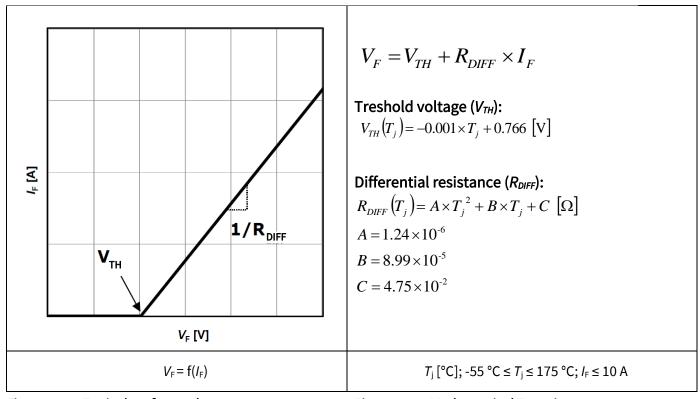


Figure 10 Equivalent forward current curve

Figure 11 Mathematical Equation



6 Package outlines

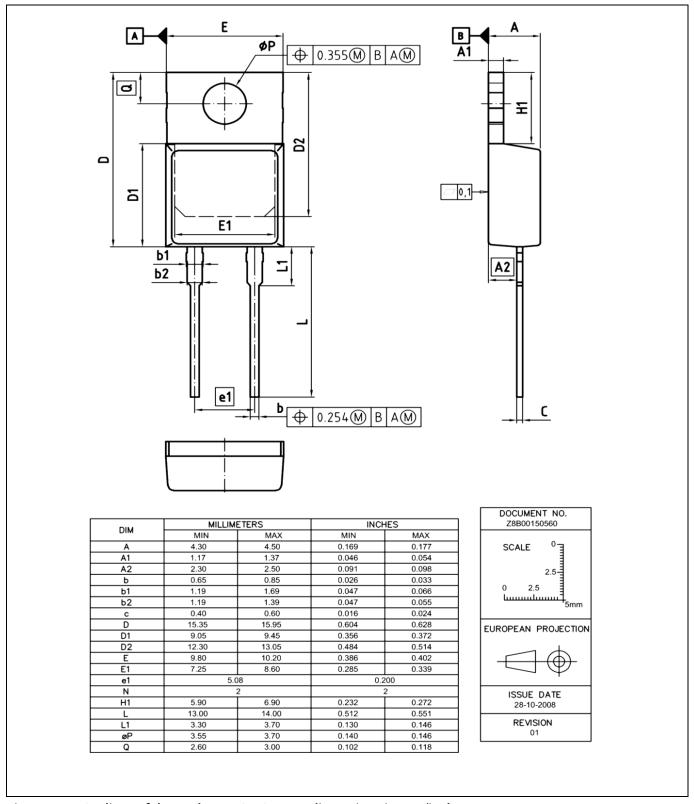


Figure 12 Outlines of the package PG-TO220-2, dimensions in mm/inches

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IDH10G65C6



Revision History

Major changes since the last revision

Revision	Date	Subject (major changes since last revision)
2.0	2017-05-23	Release of final version

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Document reference

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